

P-Channel 20 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|-----------------------------------|--------------------|----------------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) | Q _g (TYP.) (nC) | | | |
| | 0.450 at V _{GS} = -4.5 V | -0.55 | | | | |
| -20 | 0.500 at V _{GS} = -2.5 V | -0.50 | 1 | | | |
| | 0.600 at V _{GS} = -1.8 V | -0.38 | | | | |

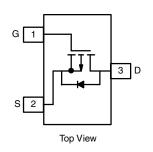
FEATURES

- TrenchFET® power MOSFET
- 100 % R tested
- Fast switching speed

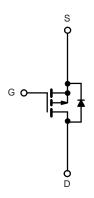


APPLICATIONS

- Load / power switch for portable devices
- Drivers: relays, solenoids, displays
- Battery operated systems







P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted) | | | | | |
|--|------------------------|-----------------------------------|-----------------------|------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | V _{DS} | -20 | V | |
| Gate-Source Voltage | | V _{GS} | ± 12 | V | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | | -0.55 ^{b, c} | | |
| | T _A = 70 °C | I _D | -0.45 ^{b, c} | ^ | |
| Pulsed Drain Current (t = 300 μs) | | I _{DM} | -1.8 | A | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | Is | -0.16 ^{b, c} | | |
| Maximum Dayyar Dissination | T _A = 25 °C | В | 0.19 ^{b, c} | 10/ | |
| Maximum Power Dissipation | T _A = 70 °C | P _D | 0.12 ^{b, c} | W | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stq} | -55 to +150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|------------|---------|------|------|--|
| PARAMETER | SYMBOL | TYPICAL | MAXIMUM | UNIT | | |
| Maximum Junction-to-Ambient ^{a, b} | t ≤ 5 s | R_{thJA} | 440 | 530 | °C/W | |
| Maximum Junction-to-Ambient 3, 2 | Steady State | | 540 | 650 | | |

Notes

- a. Maximum under steady state conditions is 650 °C/W.
- b. Surface mounted on 1" x 1" FR4 board.
- $c. \ t=5 \ s.$



| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---|-------------------------|---|------|-------|------|-----------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0$, $I_D = -250 \mu A$ | -20 | - | - | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | J 050 A | - | -12 | - | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = -250 μA | - | 1.8 | - | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = -250 \mu A$ | -0.4 | - | -1 | V | |
| Gate-Source Leakage | | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$ | - | - | ± 30 | 0 | |
| | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$ | - | - | ± 1 | | |
| Zova Cata Valtaga Dyain Cuyyant | | V _{DS} = -20 V, V _{GS} = 0 V | - | - | -1 | — μA — | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = -20 V, V _{GS} = 0 V, T _J = 85 °C | - | - | -10 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = \ge 5 \text{ V}, V_{GS} = -4.5 \text{ V}$ | -1.5 | - | - | Α | |
| | | $V_{GS} = -4.5 \text{ V}, I_D = -0.4 \text{ A}$ | - | 0.450 | - | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = -2.5 \text{ V}, I_D = -0.2 \text{ A}$ | - | 0.500 | - | Ω | |
| | | V _{GS} = -1.8 V, I _D = -0.1 A | - | 0.600 | - | | |
| Forward Transconductance | 9fs | $V_{DS} = -10 \text{ V}, I_D = 0.4 \text{ A}$ | - | 1 | - | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | - | 45 | - | pF | |
| Output Capacitance | Coss | $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | - | 15 | - | | |
| Reverse Transfer Capacitance | C _{rss} | | - | 10 | - | | |
| Tabal Oata Observe | Qg | $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -0.4 \text{ A}$ | - | 1.65 | 2.50 | nC | |
| Total Gate Charge | | | - | 1 | 2 | | |
| Gate-Source Charge | Q _{gs} | V_{DS} = -0 V, V_{GS} = -2.5 V, I_D = -0.4 | - | 0.2 | - | nc nc | |
| Gate-Drain Charge | Q _{gd} | | - | 0.26 | - | | |
| Gate Resistance | Rg | f = 1 MHz | 2.4 | 12 | 24 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | - | 9 | 18 | | |
| Rise Time | t _r | $V_{DD} = -10 \text{ V}, R_L = 33.3 \Omega$ | - | 10 | 20 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D\cong$ -0.3 A, $V_{GEN}=$ -4.5 V, $R_g=$ 1 Ω | - | 10 | 20 | | |
| Fall Time | t _f | | - | 8 | 16 | | |
| Turn-On Delay Time | t _{d(on)} | | - | 1 | 2 | ns | |
| Rise Time | t _r | V_{DD} = -10 V, R_L = 33.3 Ω | - | 8 | 16 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D\cong$ -0.3 A, V_{GEN} = -8 V, R_g = 1 Ω | - | 9 | 18 | | |
| Fall Time | t _f | | - | 5 | 10 | | |
| Drain-Source Body Diode Characteris | tics | | | | | | |
| Pulse Diode Forward Current ^a | I _{SM} | | - | - | -1.5 | Α | |
| Body Diode Voltage | V_{SD} | $I_S = -0.3 \text{ A}$ | - | -0.8 | -1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | - | 16 | 24 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | L = 0.3 A dl/d+ = 100 A/vo | - | 8 | 16 | nC | |
| Reverse Recovery Fall Time | ta | I _F = -0.3 A, dI/dt = 100 A/μs | | 11 | - | | |
| Reverse Recovery Rise Time | t _b | | - | 5 | - | ns | |

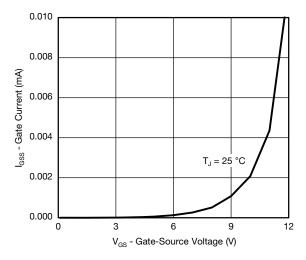
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

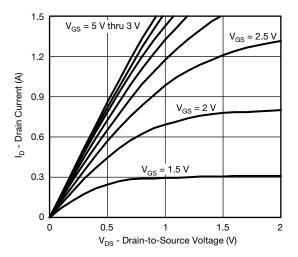
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



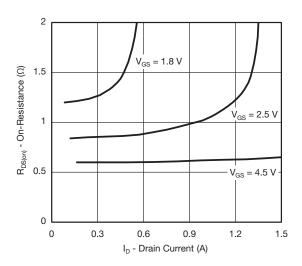
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



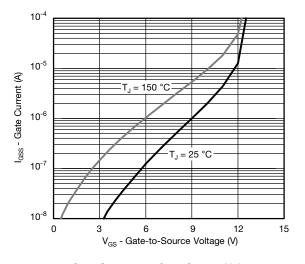
Gate Current vs. Gate-Source Voltage



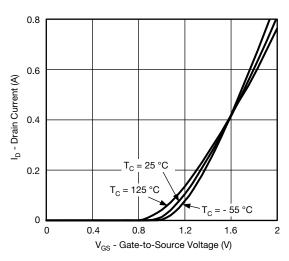
Output Characteristics



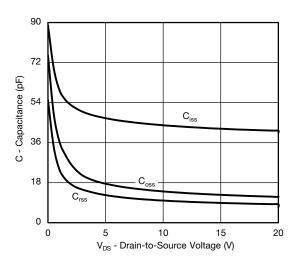
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage



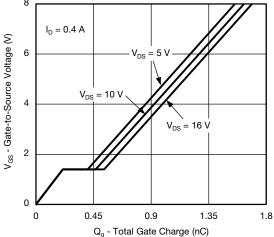
Transfer Characteristics



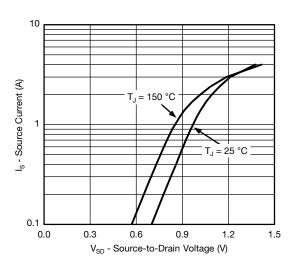
Capacitance



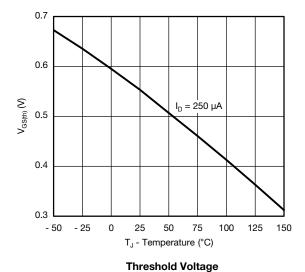
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

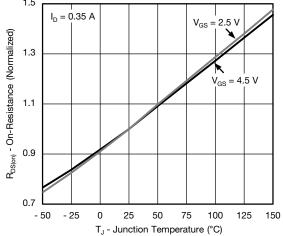


Gate Charge

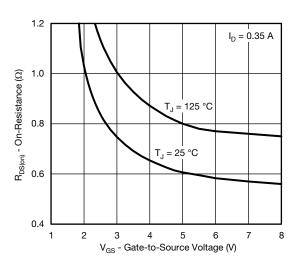


Source-Drain Diode Forward Voltage

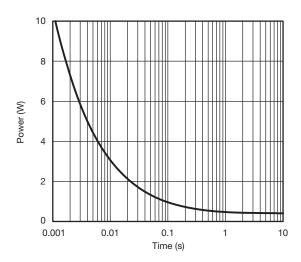




On-Resistance vs. Junction Temperature



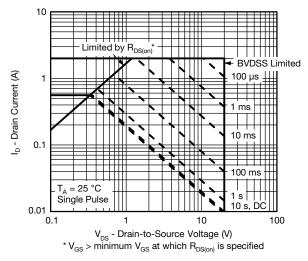
On-Resistance vs. Gate-to-Source Voltage

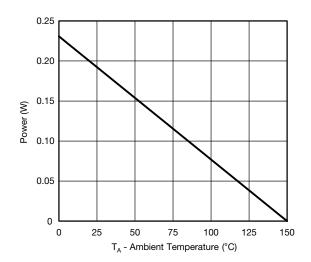


Single Pulse Power, Junction-to-Ambient



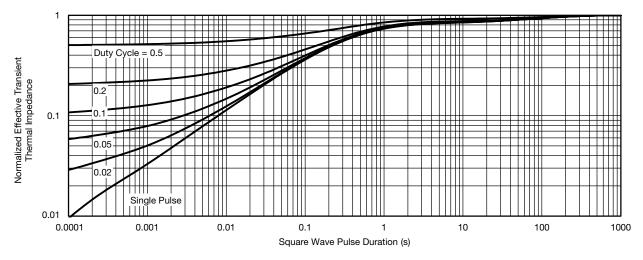
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Safe Operating Area, Junction-to-Ambient

Power Derating, Junction-to-Ambient



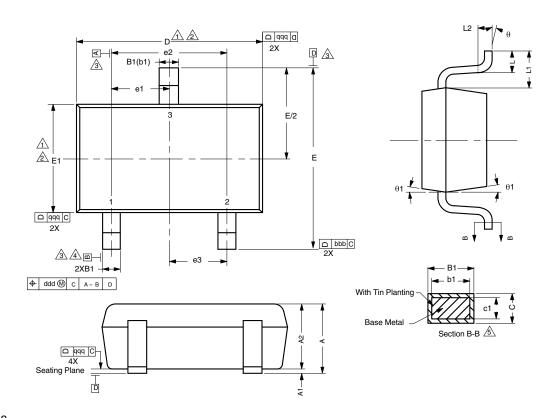
Normalized Thermal Transient Impedance, Junction-to-Ambient

E-mail: China@VBsemi TEL:86-755-83251052

5



SC-75: 3 Leads



DWG: 5868

Notes

Dimensions in millimeters will govern.

⚠Dimension D does not include mold flash, protrusions or gate burrs. Mold flash protrusions or gate burrs shall not exceed 0.10 mm per end. Dimension E1 does not include Interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.10 mm per side.

Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

Datums A, B and D to be determined 0.10 mm from the lead tip.

A Terminal positions are shown for reference only.

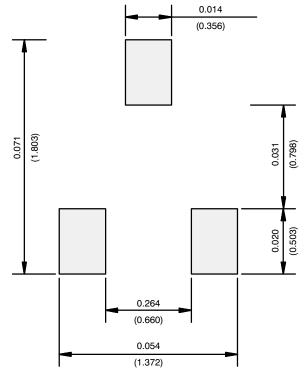
These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

| DIMENSIONS | TOLERANCES | | |
|------------|------------|--|--|
| aaa | 0.10 | | |
| bbb | 0.10 | | |
| ccc | 0.10 | | |
| ddd | 0.10 | | |

| DIM. | N | NOTE | | |
|------|-----------|-------|------|------|
| | MIN. | NOM. | MAX. | NOTE |
| А | - | - | 0.80 | |
| A1 | 0.00 | - | 0.10 | |
| A2 | 0.65 | 0.70 | 0.80 | |
| B1 | 0.19 | - | 0.24 | 5 |
| b1 | 0.17 | - | 0.21 | |
| С | 0.13 | - | 0.15 | 5 |
| c1 | 0.10 | - | 0.12 | 5 |
| D | 1.48 | 1.575 | 1.68 | 1, 2 |
| E | 1.50 | 1.60 | 1.70 | |
| E1 | 0.66 | 0.76 | 0.86 | 1, 2 |
| e1 | 0.50 BSC | | | |
| e2 | 1.00 BSC | | | |
| e3 | 0.50 BSC | | | |
| L | 0.15 | 0.205 | 0.30 | |
| L1 | 0.40 ref. | | | |
| L2 | 0.15 BSC | | | |
| q | 0° | - | 8° | |
| q1 | 4° | - | 10° | |



RECOMMENDED MINIMUM PADS FOR SC-75: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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